IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hutchison et al.
Application No. Not yet assigned
Filed: Filed herein
Confirmation No. Not yet assigned
For: SCAFFOLD-ORGANIZED CLUSTERS AND ELECTRONIC DEVICES MADE USING SUCH CLUSTERS
Examiner: Not yet assigned
Art Unit: Not yet assigned
Attorney Reference No. 1505-67959

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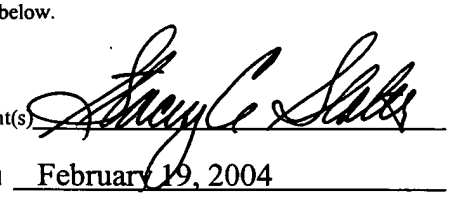
Attorney for Applicant(s) 

Date Mailed February 19, 2004

INFORMATION DISCLOSURE STATEMENT FOR CONTINUING APPLICATIONS

Listed on the accompanying form PTO-1449 are several English-language documents. Applicants respectfully request that such documents be listed as references cited on the issued patent.

The present application relies upon U.S. Patent Application No. 09/817,708, which was filed March 26, 2001, for an earlier filing date under 35 U.S.C. § 120. Furthermore, documents listed on the accompanying form PTO-1449 were disclosed to or cited by the Patent Office in the earlier U.S. application.

Copies of the documents listed on the accompanying form PTO-1449 that were cited by applicants in the earlier application need not be sent to the Patent Office pursuant to 37 C.F.R. § 1.98. However, applicants will furnish the Patent Office with such copies upon request.

Copies of documents listed on the accompanying form PTO-1449 that were cited by the Patent Office in the earlier application are enclosed.

Please charge any fees that may be required to file this Information Disclosure Statement to Deposit Account No. 02-4550. A duplicate copy of this sheet is enclosed.

The filing of this Information Disclosure Statement shall not be construed to be an admission that the information cited in the statement is, or is considered to be, prior art or otherwise material to patentability as defined in 37 C.F.R. §1.56.

Respectfully submitted,

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT		
	Attorney Docket Number	1505-67959
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	Filing Date	
	First Named Inventor	Hutchison
	Art Unit	
	Examiner Name	

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		Alivisatos, A., *et al.*, Organization of 'Nanocrystal Molecules' using DNA, *Nature*, 382:609-611, 1996.

EXAMINER SIGNATURE:	DATE CONSIDERED:

* Examiner: Initial if reference considered, whether or not in conformance with MPEP 609. Draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.

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